

## Specification



Processor	CPU	Intel® ALDER Lake-P, TDP 15W
Memory	Type	2 x So DIMM DDR4 ,3200MHz
	Max	Max. 32GB
Storage	Type	1 x 2280 M.2, NVMe PCIe x2 SSD Signal, Co-Lay M.2 SATA SSD
	Chipset	Intel® UHD Graphics
Network	Wireless/BT	1 x M.2 2230 Support 802.11 b/g/n/ac/ax/BT
	4G/5G Slot	1 x M.2 3042/3052 4G/5G Module
	LAN	2 x RTL 8111H Gigabit Ethernet card
TPM	Option	Physical TPM2.0 Chip
Audio I/O	Chipset	Realtek ALC897 HD Audio IC
		HDMI2.0 , 4K/60Hz
		HDMI2.0 , 4K60Hz
Rear I/O	Chipset	DP1.2 , 4K/60Hz
		USB3.0
		RJ45 x 2
Front I/O interface	Chipset	USB2.0 x 3
		12-19V DC IN, 2.5/5.5 DC Jack
		USB3.0 x 2
Other I/O	Chipset	Line out 3.5mm
		Mic in 3.5mm
		Power button
Function	Chipset	COM x 2, DB-9 (RS232)
		Watchdog Support
Dimension	SIZE	190(L)*148(W)*26(H) mm
	Mounting	VESA Mounting
Environment	Temperature	Working: -5°C~45°C Storage : -20°C~70°C
	Relative humidity	10%~90% (non-condensing)



## Features

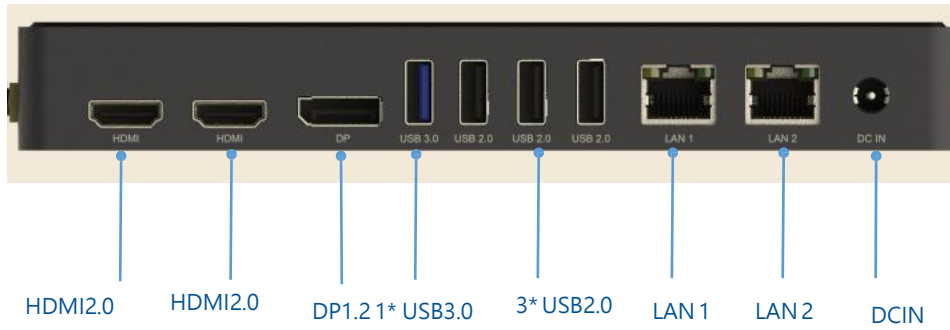
- Intel® ALDER Lake-P platform
- Dual So DIMM DDR4 Memory
- 3 x USB3.0, 3 x USB2.0
- Dual Ethernet Port
- Support M.2 WIFI Moduel
- Three displays: 2\* HDMI+DP Display

## Front I/O



Power Button    USB-C    2\* USB3.0    Mic in    Lineout

## Rear I/O



## Ordering Information

Model	Description
K105-I3	I3 /M.2 SSD/ Dual DIMM DDR4 Memory/ WIFI+BT module/ 1* HDM2.0 /1* DP1.2/TPM2.0
K105-I5	I5 /M.2 SSD/ Dual DIMM DDR4 / WIFI+BT module/ 1* HDM2.0 /1* DP1.2 /TPM2.0
K105-I7	I7 /M.2 SSD/ Dual DIMM DDR4 / WIFI+BT module/ 1* HDM2.0 /1* DP1.2 /TPM2.0

## Packing list

Description	Qty
Mini PC	20 pcs ( workpackage )
Manual	TBD
Drive disk	TBD



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